

 $I_D, T_A = 25$ °C

5A



N-Channel MOSFET

Features

- High density cell design for ultra low R_{DS(ON)}
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

Applications

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

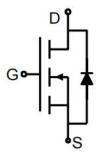


R_{DS(ON)},typ@10V

 $135 m\Omega$

 BV_{DSS} , $T_A = 25$ °C

100V



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Description

The SK05N10A uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

Absolute Maximum Ratings(T_A=25°C,unless otherwise noted.)

Parameter	Symbol	Limit	Unit
Drain-source Voltage	$ m V_{DS}$	100	V
Gate-source Voltage	$ m V_{GS}$	±20	V
Drain Current-Continuous	I_D	5	A
Drain Current-Pulsed ⁽¹⁾	I_{DM}	20	A
Maximum Power Dissipation	P_D	3	W
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55~+150	°C
Thermal Resistance,Junction-to-Ambient ⁽²⁾	$R_{ heta JA}$	41.7	°C/W

Electrical Characteristics(T_A=25°C,unless otherwise noted.)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-source breakdown voltage	$\mathrm{BV}_{\mathrm{DSS}}$	V _{GS} =0V,I _D =250μA	100	105		V
Drain-source leakage current	I _{DSS}	V _{DS} =80V,V _{GS} =0V			800	nA

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SK05N10A

Gate-source leakage current	I_{GSS}	V _{DS} =0V,V _{GS} =±20V			±30	μΑ
On Characteristics ⁽³⁾						
Gate Threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250μA	1	2	3	V
Drain-source on resistance	R _{DS(on)}	V _{GS} =10V,I _D =5A		135	150	mΩ
Forward Trans conductance	g _{FS}	V _{DS} =5V,I _D =2.9A		8		S
Dynamic Characteristics ⁽⁴⁾						
Input Capacitance	C _{iss}			690		pF
Output capacitance	C_{oss}	V_{DS} =25V, V_{GS} =0V, F=1.0MHz		120		pF
Revers Transfer capacitance	C_{rss}			90		pF
Switching Characteristics ⁽⁴⁾	·					
Turn-on Delay Time	t _{d(on)}			11		nS
Turn-on Rise Time	$t_{\rm r}$	$V_{DS}=30V, V_{GS}=10V,$		7.4		nS
Turn-off Delay Time	$t_{d(off)}$	$ \begin{array}{c} R_L=15\Omega, R_G=2.5\Omega, \\ I_D=2A \end{array} $		35		nS
Turn-off Fall Time	$t_{ m f}$			9.1		nS
Total Gate Charge	Qg			15.5		nC
Gate-Source Charge	Q_{gs}	$V_{DS}=30V,I_{D}=3A, V_{GS}=10V$		3.2		nC
Gate-Drain Charge	Q_{gd}			4.7		nC
Drain-Source Diode Characteristi	ics	•	•	•		
Diode Forward Voltage ⁽³⁾	V _{SD}	V _{GS} =0V,I _D =6A			1.2	V
Diode Forward Current ⁽²⁾	Is				6	A
		·				

Notes:

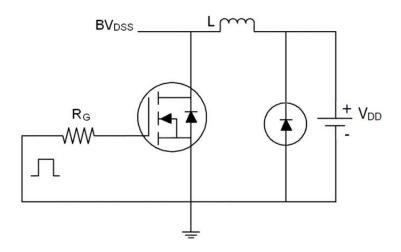
- 1.Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production

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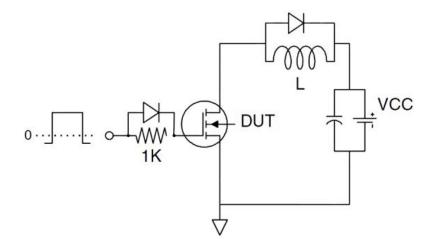


Test Circuit

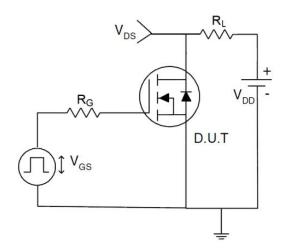
1) Eas test circuit



2) Gate charge test circuit



3) Switch time test circuit



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Typical Characteristics

Figure 1. Source-Drain Diode Forward Voltage

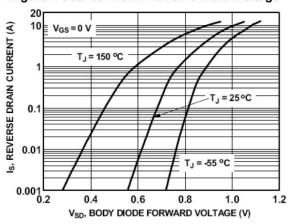


Figure3. Output characteristics

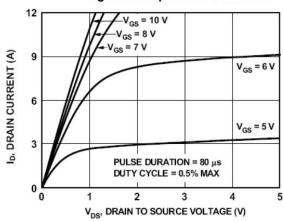


Figure 5. Static drain-source on resistance

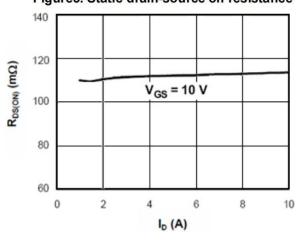


Figure 2. Safe operating area

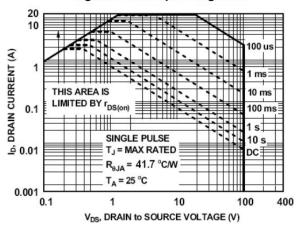


Figure 4. Transfer characteristics

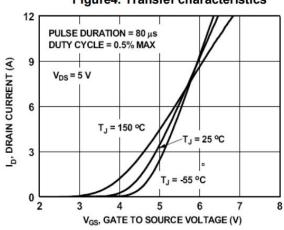
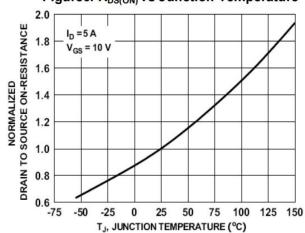


Figure 6. R_{DS(ON)} vs Junction Temperature



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Figure 7. BV_{DSS} vs Junction Temperature

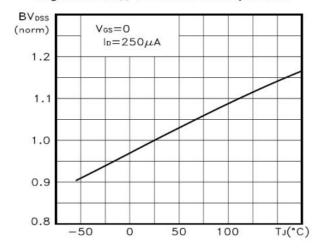
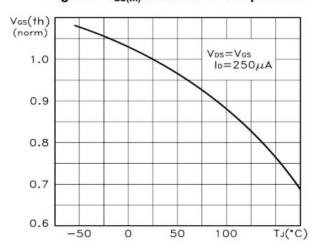
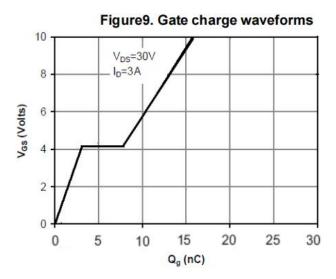
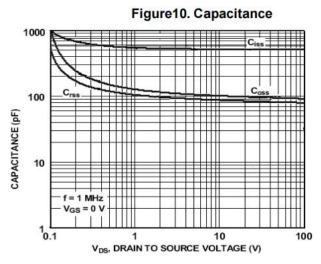


Figure8. V_{GS(th)} vs Junction Temperature







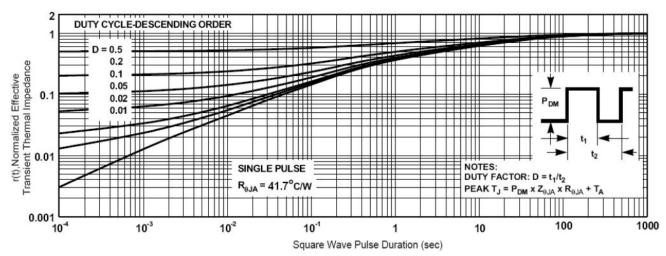


Figure 11. Normalized Maximum Transient Thermal Impedance

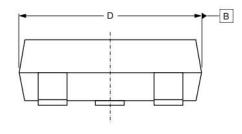
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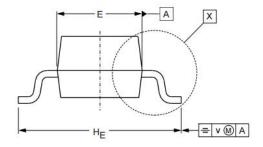


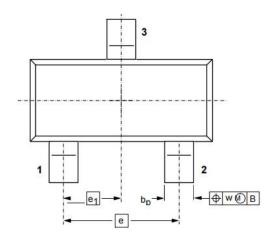
Package Information

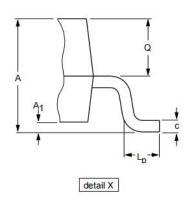
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Dimensions in mm









DIMENSIONS

Unit	A	Al Max.	b _p	С	D	Е	e	e ₁	$H_{\rm E}$	L _p	Q	V	W
mm	1.1 0.9	0.1	0.48 0.38	0.15 0.09	3.0 2.8	1.7 1.5	1.9	0.95	3.00 2.65	0.45 0.15	0.55 0.45	0.2	0.1

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